

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No.09/784,234
Filing DateFebruary 14, 2001
Inventor.....Nagano et al.
Assignee.....Honeywell International Inc.
Group Art Unit.....1742
Examiner Ip, S.
Attorney's Docket No. 30-5000-(4015)-DIV1
Title: Conductive Integrated Circuit Metal Alloy Interconnections, Electroplating Anodes,
Metal Alloys for Use as a Conductive Interconnection in an Integrated Circuit, and
Physical Vapor Deposition Targets.

RESPONSE TO DECEMBER 17, 2002 FINAL OFFICE ACTION
TO ACCOMPANY RCE FILING

To: Box RCE
Assistant Commissioner for Patents
Washington, D.C. 20231

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AMENDMENTS

In the Claims

Please replace the claims with the following clean version of the entire set of pending claims, in accordance with 37 C.F.R. § 1.121(c)(1)(i). Cancel all previous versions of any pending claim.

A marked up version showing amendments to any claims being changed is provided in one or more accompanying pages separate from this amendment in accordance with 37 C.F.R. § 1.121(c)(1)(ii). Any claim not accompanied by a marked up version has not been